MOSFETs Silicon N-channel MOS (U-MOSIV)

# **TK80A04K3L**

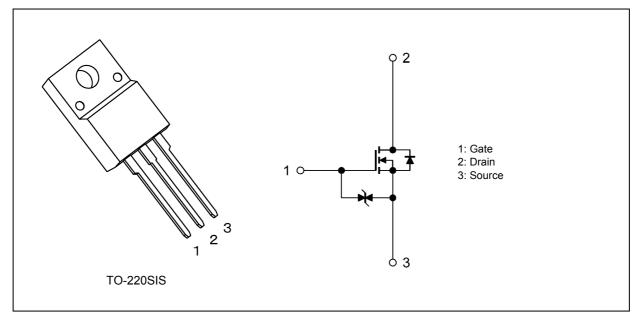
## 1. Applications

- Automotive
- Switching Voltage Regulators
- Motor Drivers

### 2. Features

- (1) Low drain-source on-resistance:  $R_{DS(ON)} = 1.9 \text{ m}\Omega \text{ (typ.)} (V_{GS} = 10 \text{ V})$
- (2) Low leakage current:  $I_{DSS} = 10 \ \mu A \ (max) \ (V_{DS} = 40 \ V)$
- (3) Enhancement mode:  $V_{th}$  = 2.0 to 3.0 V ( $V_{DS}$  = 10 V,  $I_D$  = 1 mA)

## 3. Packaging and Internal Circuit



## 4. Absolute Maximum Ratings (Note) ( $T_a = 25^{\circ}C$ unless otherwise specified)

Characteris	Symbol	Rating	Unit		
Drain-source voltage			V <sub>DSS</sub>	40	V
Gate-source voltage			V <sub>GSS</sub>	±20	
Drain current (DC)		(Note 1)	I <sub>D</sub>	80	A
Drain current (pulsed)		(Note 1)	I <sub>DP</sub>	320	1
Power dissipation	(T <sub>c</sub> = 25°C)		PD	48	W
Single-pulse avalanche energy		(Note 2)	E <sub>AS</sub>	665	mJ
Avalanche current			I <sub>AR</sub>	80	A
Channel temperature		(Note 3)	T <sub>ch</sub>	175	°C
Storage temperature		(Note 3)	T <sub>stg</sub>	-55 to 175	]

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

### 5. Thermal Characteristics

Characteristics	Symbol	Max	Unit
Channel-to-case thermal resistance	R <sub>th(ch-c)</sub>	3.125	°C/W
Channel-to-ambient thermal resistance	R <sub>th(ch-a)</sub>	62.5	

Note 1: Ensure that the channel temperature does not exceed 175°C.

Note 2: V\_DD = 25 V, T\_ch = 25°C (initial), L = 108  $\mu H, R_G$  = 25  $\Omega, I_{AR}$  = 80 A

Note 3: The definitions of the absolute maximum channel and storage temperatures are based on AEC-Q101.

Note: This transistor is sensitive to electrostatic discharge and should be handled with care.

### 6. Electrical Characteristics

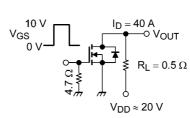
## 6.1. Static Characteristics (T<sub>a</sub> = 25°C unless otherwise specified)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage current	I <sub>GSS</sub>	$V_{GS}$ = ±16 V, $V_{DS}$ = 0 V	_	_	±10	μA
Drain cut-off current	I <sub>DSS</sub>	V <sub>DS</sub> = 40 V, V <sub>GS</sub> = 0 V	_	_	10	
Drain-source breakdown voltage	V <sub>(BR)DSS</sub>	I <sub>D</sub> = 10 mA, V <sub>GS</sub> = 0 V	40		_	V
Drain-source breakdown voltage (Note 4)	V <sub>(BR)DSX</sub>	I <sub>D</sub> = 10 mA, V <sub>GS</sub> = -20 V	20	_	_	
Gate threshold voltage	V <sub>th</sub>	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 1 mA	2.0	—	3.0	
Drain-source on-resistance	R <sub>DS(ON)</sub>	V <sub>GS</sub> = 6 V, I <sub>D</sub> = 40 A		2.3	3.5	mΩ
		V <sub>GS</sub> = 10 V, I <sub>D</sub> = 40 A		1.9	2.4	

Note 4: If a reverse bias is applied between gate and source, this device enters V<sub>(BR)DSX</sub> mode. Note that the drainsource breakdown voltage is lowered in this mode.

### 6.2. Dynamic Characteristics ( $T_a = 25^{\circ}C$ unless otherwise specified)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Input capacitance	C <sub>iss</sub>	V <sub>DS</sub> = 10 V, V <sub>GS</sub> = 0 V, f = 1 MHz	_	9400	—	pF
Reverse transfer capacitance	C <sub>rss</sub>			1200	_	
Output capacitance	C <sub>oss</sub>		_	1900	_	
Switching time (rise time)	tr	See Figure 6.2.1.	_	20	_	ns
Switching time (turn-on time)	t <sub>on</sub>		_	42	_	
Switching time (fall time)	t <sub>f</sub>		_	43	_	
Switching time (turn-off time)	t <sub>off</sub>		_	158	_	



Duty  $\leq$  1%, t<sub>w</sub> = 10  $\mu$ s

#### Fig. 6.2.1 Switching Time Test Circuit

## 6.3. Gate Charge Characteristics ( $T_a = 25^{\circ}C$ unless otherwise specified)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Total gate charge (gate-source plus gate-drain)	Qg	$V_{DD} \approx 32 \text{ V}, \text{ V}_{GS} \text{ = } 10 \text{ V}, \text{ I}_{D} \text{ = } 80 \text{ A}$	_	190	—	nC
Gate-source charge	Q <sub>gs</sub>		_	127	_	
Gate-drain charge	Q <sub>gd</sub>			63	_	

### 6.4. Source-Drain Characteristics ( $T_a = 25^{\circ}C$ unless otherwise specified)

Characteristics		Symbol	Test Condition	Min	Тур.	Max	Unit
Reverse drain current (DC)	(Note 5)	I <sub>DR</sub>	—		—	80	А
Reverse drain current (pulsed)	(Note 5)	I <sub>DRP</sub>			—	320	
Diode forward voltage		V <sub>DSF</sub>	$I_{DR}$ = 80 A, $V_{GS}$ = 0 V	-	—	-1.2	V
Reverse recovery time		t <sub>rr</sub>	I <sub>DR</sub> = 80 A, V <sub>GS</sub> = 0 V	_	64	_	ns
Reverse recovery charge		Q <sub>rr</sub>	-dI <sub>DR</sub> /dt = 50 A/μs		48	_	nC

Note 5: Ensure that the channel temperature does not exceed 175°C.

## 7. Marking (Note)

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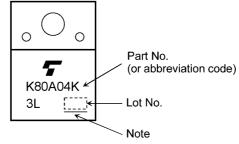
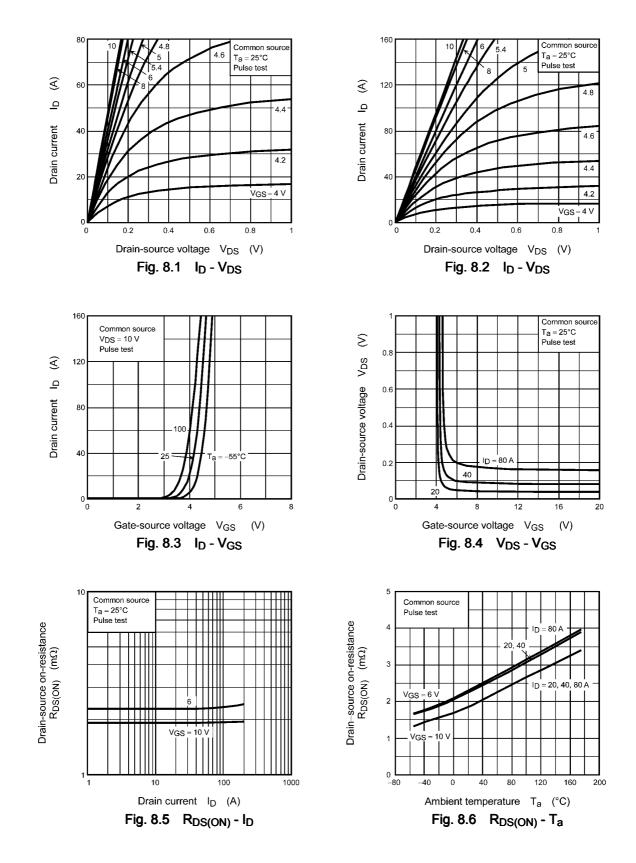


Fig. 7.1 Marking

Note: A line under a Lot No. identifies the indication of product Labels. Not underlined: [[Pb]]/INCLUDES > MCV Underlined: [[G]]/RoHS COMPATIBLE or [[G]]/RoHS [[Pb]] Please contact your TOSHIBA sales representative for details as to environmental matters such as the RoHS compatibility of Product. The RoHS is the Directive 2002/95/EC of the European Parliament and of the Council of 27 January 2003 on the restriction of the use of certain hazardous substances in electrical and electronic equipment.

## 8. Characteristics Curves (Note)



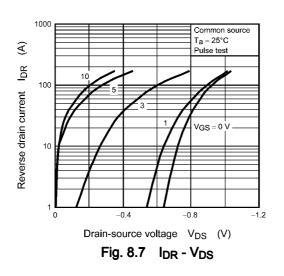
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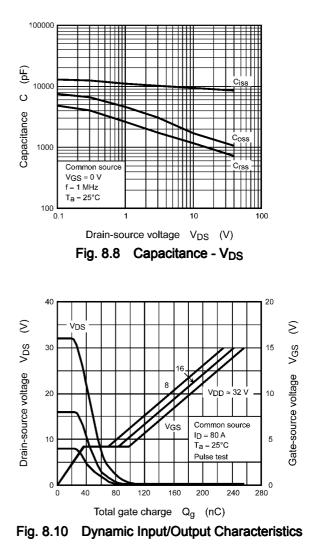
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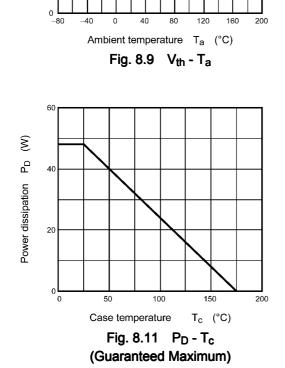
Gate threshold voltage V<sub>th</sub>



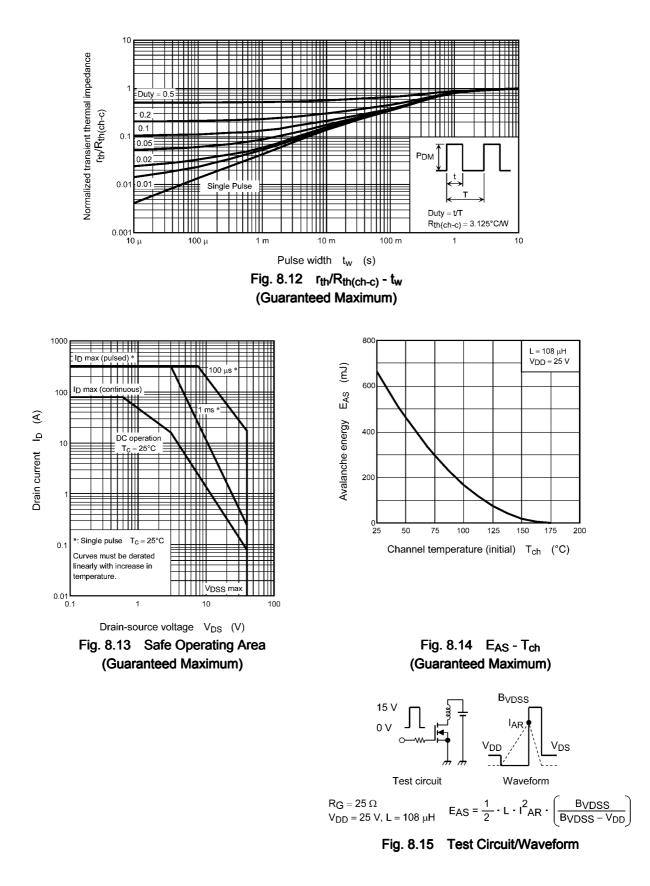
Common source  $V_{DS} = 10 V$  $I_{D} = 1 mA$ 

Pulse test







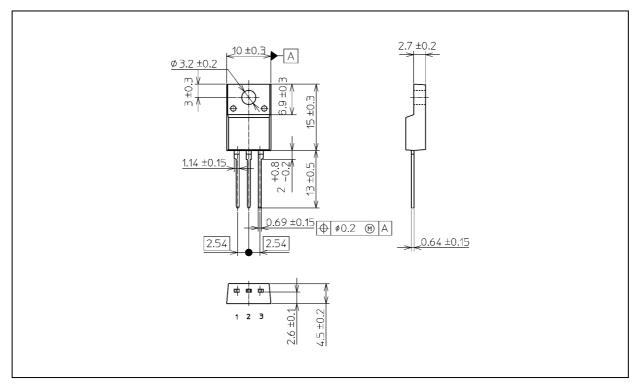


Note: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.



## Package Dimensions

Unit: mm



#### Weight: 1.7 g (typ.)

	Package Name(s)
TOSHIBA: 2-10U1S	
Nickname: TO-220SIS	

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